

AMCA31-2R450G-S1F-T3



3.2 x 1.6 x 1.2mm RoHS/RoHS II Compliant MSL = 1

Features

- 2450MHz, Bandwidth ≥90MHz
- Suitable for RoHS compliant reflow
- Gain 0.5dBi (Peak) / -1dBi (Average)
- VSWR <2:1
- Small size 3.2 x 1.6 x 1.2mm (0.125 x 0.62 x 0.047 inch)
- Non Ground Mounting type.
- Power Handling 3W Max
- Matched to 50 Ohm.

Applications

- Wireless application Bluetooth / WiFi (2.445GHz)
- High density applications
- Bluetooth headsets or ear pieces
- Computer mouse and keyboards
- PROFINET Industrial automation
- Video Game systems
- Alternative to larger PCB solution

Electrical Specifications

Parameter	Min.	Typ.	Max.	Units	Note
Frequency		2450		MHz	
Bandwidth	100			MHz	
Peak Gain		-3.53		dBi	
Average Gain		-1		dBi	
VSWR			2		
Impedance		50		Ω	
Power Capability			3	W	

Environmental Characteristics

Parameters	Specification	
Environmental friendly	Pb-free	
MSL	1	
Operating Temperature	-40 °C to + 85 °C	
Storage Temperature	-10 °C to +40 °C	
Relative Humidity	70%	



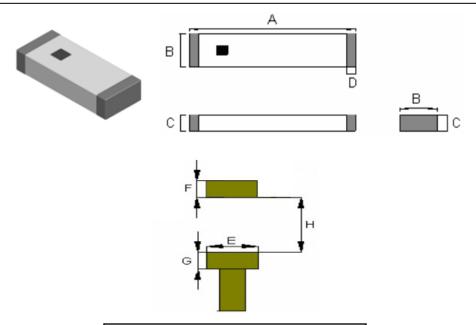


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Product Dimensions and PCB Land Drawing (Unit: mm)



This is the feed-line to the Antenna and should be matched to 50 Ohms based upon the PCB dielectric parameters.

Series	A	В	C	D	E	F	G	H
AMCA31	3.2±0.2	1.6±0.2	1.2±0.2	0.5±0.2	1.6±0.2	0.8±0.2	0.8±0.2	2.6±0.2

Terminal Configurations



No.	Terminal Name	No.	Terminal Name
Pad 1	Feed Point	Pad 2	NC





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Application Test Circuit & PCB layouts - Default Layouts

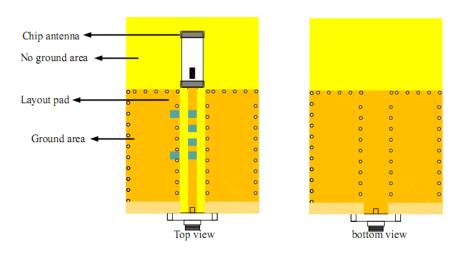
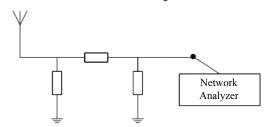


Figure shows the PCB layout highlighting the Ground and No Ground areas and trace feed line to the chip antenna.

Matching Circuit and Reference Values

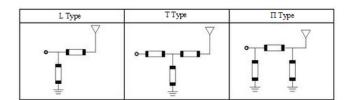
Electrical Performance with matching circuit:



Component	Description	Value	
Antenna	AMCA31-2R450G-S1F-T3		
Consoiter	*Series C	$0.5 \sim 10 \text{ pF}$	
Capacitor	*Shunt C	33pF, 100 pF	
Inductor	Series L	1.0 ∼ 6nH	
	Shunt L	1.0 ∼ 6nH	

Passive Test with Network Analyzer

Note: Recommendation is to pre-place the π -type circuit layout circuit which will offer full flexibility to match the antenna to 50 Ohm in the final product layout with one of the match configurations below. Depending on matching, NC will apply to certain components.





^{*}Series: Connected between antenna and feeding line in series.

^{*}Shunt: Connected between antenna and feeding line in parallel

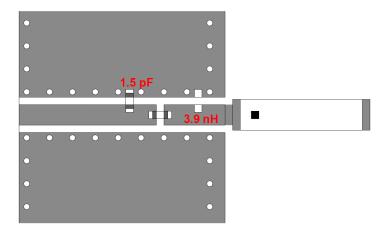


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Matching Circuit on Evaluation Board



- Line width should be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness.
- The component values given above will be vary based on the PCB layout

Return Loss, VSWR and Impedance Characteristics

Before Matching 1:-18.216 dB 6.9824 o 398.36 pH 1: 1.2800 CH1 Markers Min PRm .121140247 GHz 2.792412426 GHz Q: 23.051 1_loss: -18.216 dB TARGET VALUE NOT FOUND PRm CH2 Markers CH3 Markers 2.79241 GHz 3: 29.633 n -15.612 n 2.73184 GHz 2.85298 GHz START 1.500 000 000 GHz



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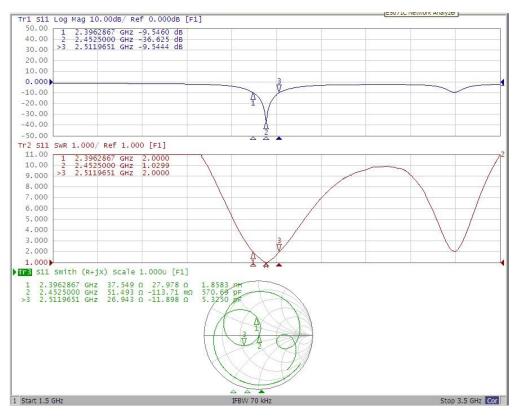
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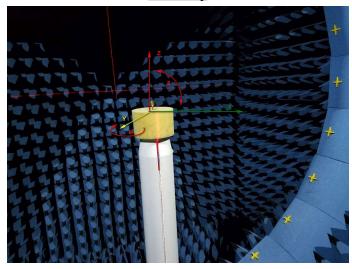
Return Loss, VSWR and Impedance Characteristics Cont.

After Matching



Radiation Pattern and Gain

Test Setup







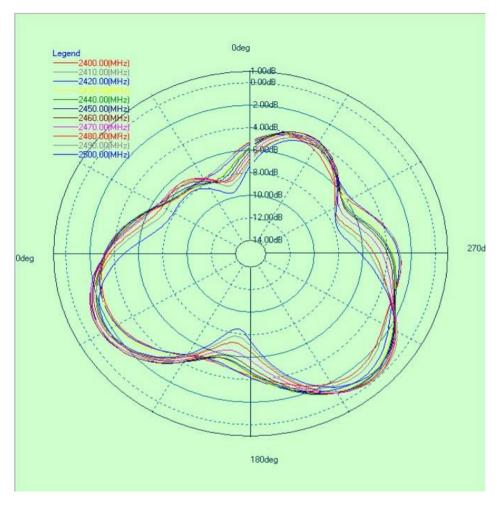
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Radiation Pattern and Gain

XY Plane







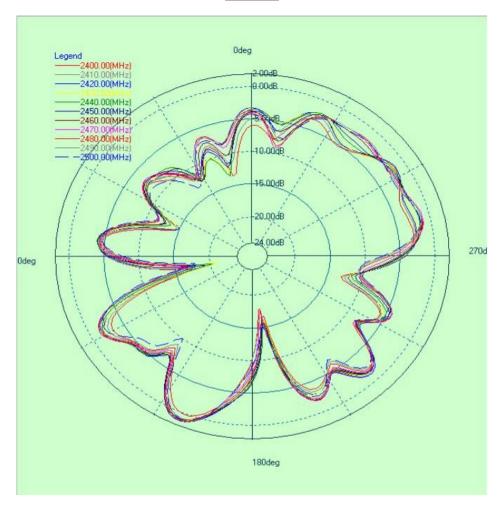
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Radiation Pattern and Gain

XZ Plane







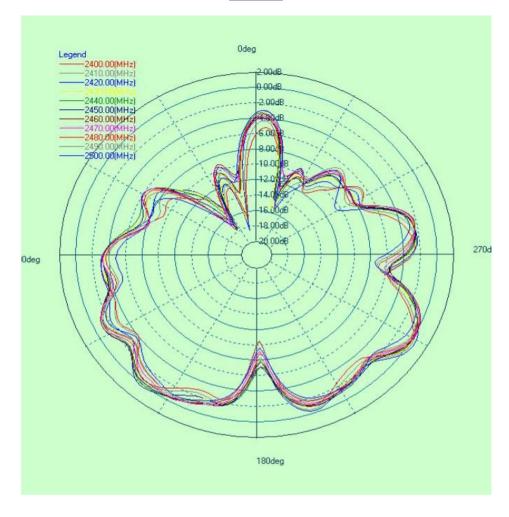
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Radiation Pattern and Gain

YZ Plane







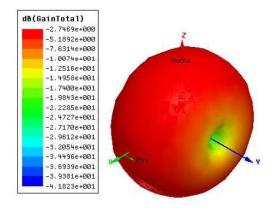
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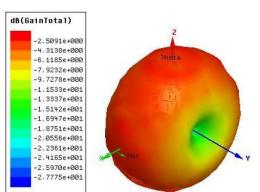


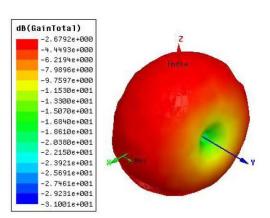
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Radiation Pattern and Gain

3D - Pattern | (2400 MHz, 2450 MHz, 2500 MHz)







Gain

Frequency (MHz)	Gain (dBi)
2400	-4.125434820
2410	-4.180958401
2420	-3.877599807
2430	-3.930632294
2440	-3.676540694
2450	-3.582882743
2460	-3.534294730
2470	-3.598055402
2480	-3.690017588
2490	-3.876259790
2500	-3.918544199





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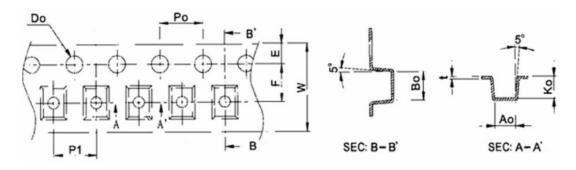


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Packaging

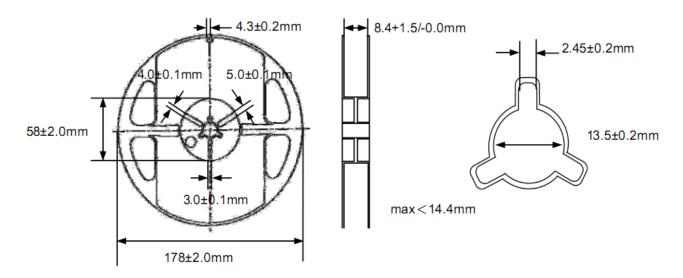
T3=3000 Units per reel

Tape Dimensions (Unit: mm)



W	8.00±0.10	D0	1.50 +0.10 / -0.0
P1	4.00±0.10	PO	4.00±0.10
E	1.75±0.10	K0	1.50±0.10
F	3.50±0.15	A0	1.80±0.10
В0	3.50±0.10	t	0.22±0.05

Reel Dimensions (Unit: mm)







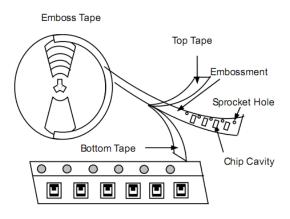
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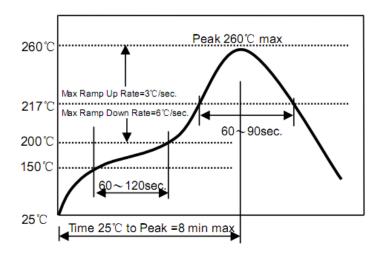
Packaging

Tape Drawing



Note: The sprocket holes are to the right as the tape is pulled toward the user.

Reflow Profile



• Preheat condition: $150 \sim 200$ °C / $60 \sim 120$ sec

• Allowed time above 217 °C: 60~90sec

• Max temp: 260 °C

Max time at max temp: 10 sec
Solder paste: Sn/3.0Ag/0.5Cu
Allowed Reflow time: 2x max

[Note: The reflow profile in the above table is only for qualification and is not meant to specify board assembly profiles. Actual board assembly profiles must be based on the customer's specific board design, solder paste and process, and should not exceed the parameters as the Reflow profile shows.]



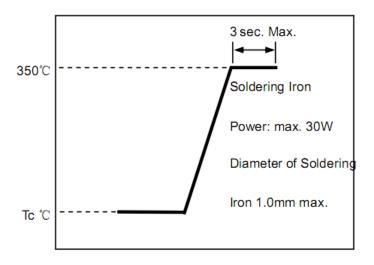


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Manual Soldering



Iron soldering power: Max.30 W
Pre-heating: 150 °C / 60 sec

• Soldering Tip temperature: 350 °C max.

Soldering time: 3 sec Max.
Solder paste: Sn/3.0Ag/0.5Cu
Max. 1 time for iron soldering

[Note: Take care not to apply the tip of the soldering iron to the terminal electrodes.]

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